

# EUROPEAN PATENT OFFICE

## Patent Abstracts of Japan

PUBLICATION NUMBER : 2003197460  
PUBLICATION DATE : 11-07-03

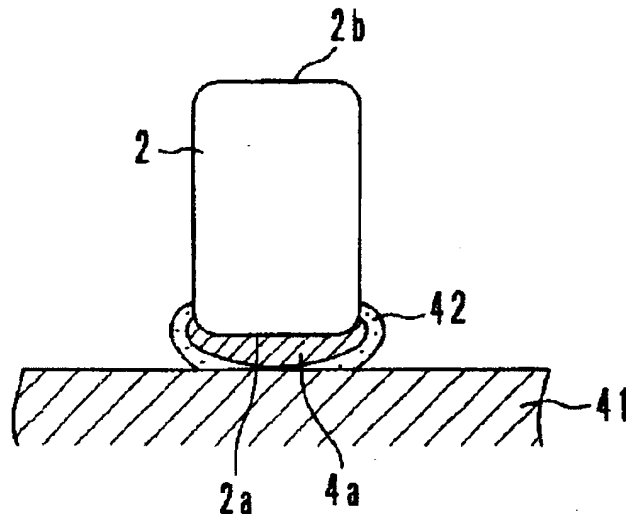
APPLICATION DATE : 26-12-01  
APPLICATION NUMBER : 2001394817

APPLICANT : MURATA MFG CO LTD;

INVENTOR : YAMAMOTO SHIGEKATSU;

INT.CL. : H01G 4/30

TITLE : METHOD FOR MANUFACTURING  
ELECTRONIC COMPONENT, AND THE  
ELECTRONIC COMPONENT



ABSTRACT : PROBLEM TO BE SOLVED: To provide a method for manufacturing an electronic component, in which an external electrode having a region in which a conductive resin of a second electrode layer (buffer layer) does not exist on a central part of the end face of an insulating material can be formed with proper productivity and at a low cost.

SOLUTION: The method for manufacturing the electronic component comprises steps of pushing the end face 2a of a laminate 2 against a metal base 41 before a conductive resin 42 adhered to the laminate 2 is dried. Since the first electrode layer 4a is made to swell in a protrusion state, a resin 42 coating a part 24 of the end face 2a of the laminate 2 is transferred to a base 21 in a relatively large amount.

COPYRIGHT: (C)2003,JPO

BEST AVAILABLE COPY